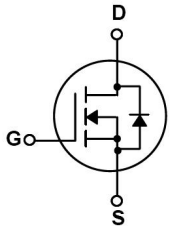
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/ Features

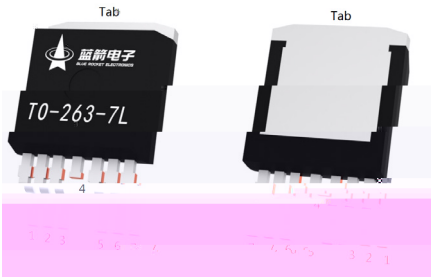
/ Applications

BMS

/ Equivalent Circuit



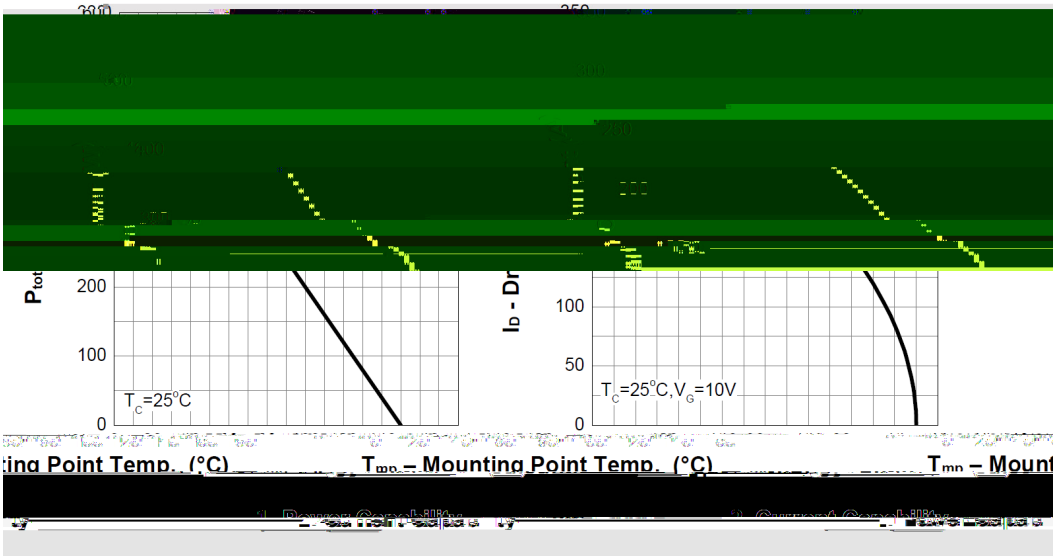
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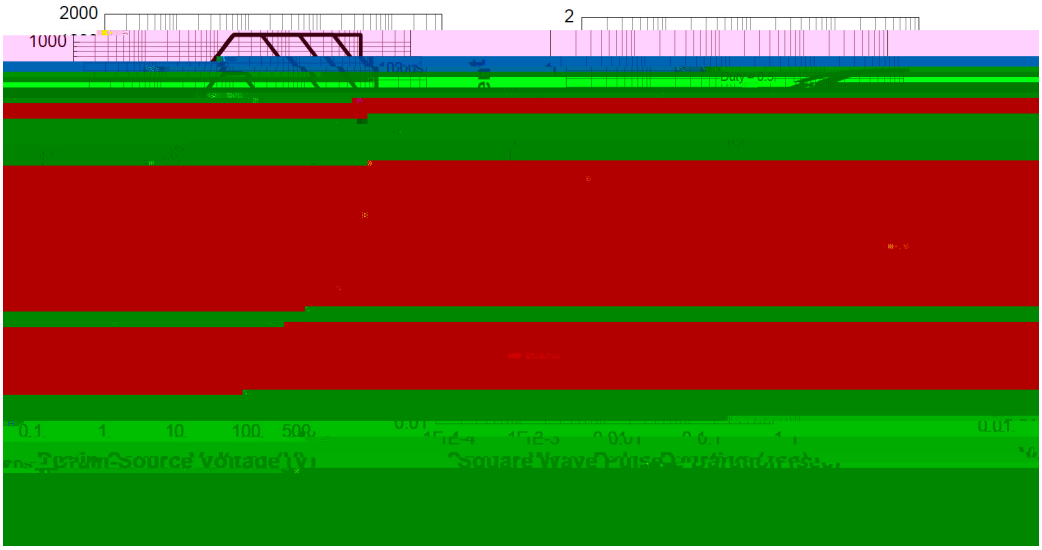


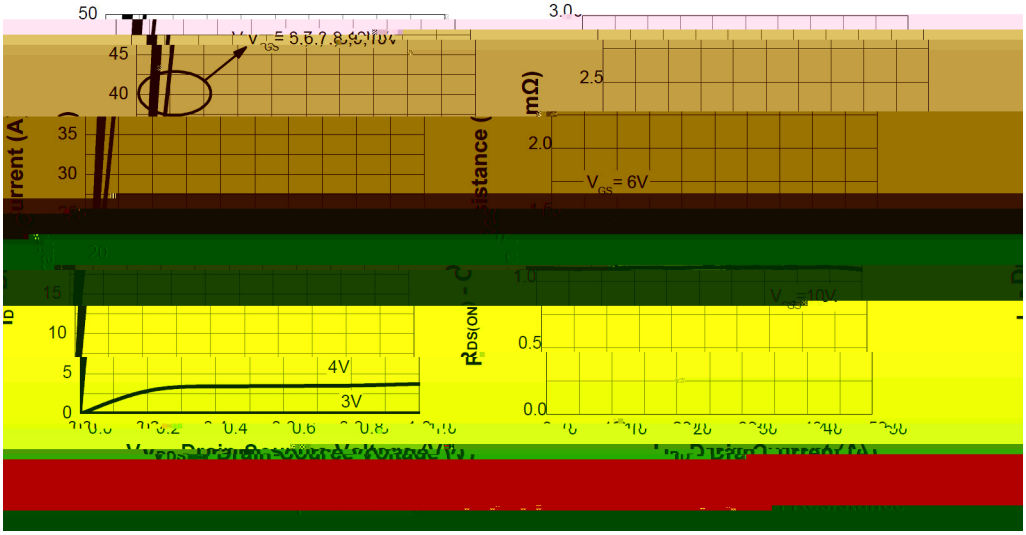
/ Marking

				V
				A
				A
				A
				V
				A
				mJ
				W
		$R_{\theta JA}$		/W
		$R_{\theta JC}$		

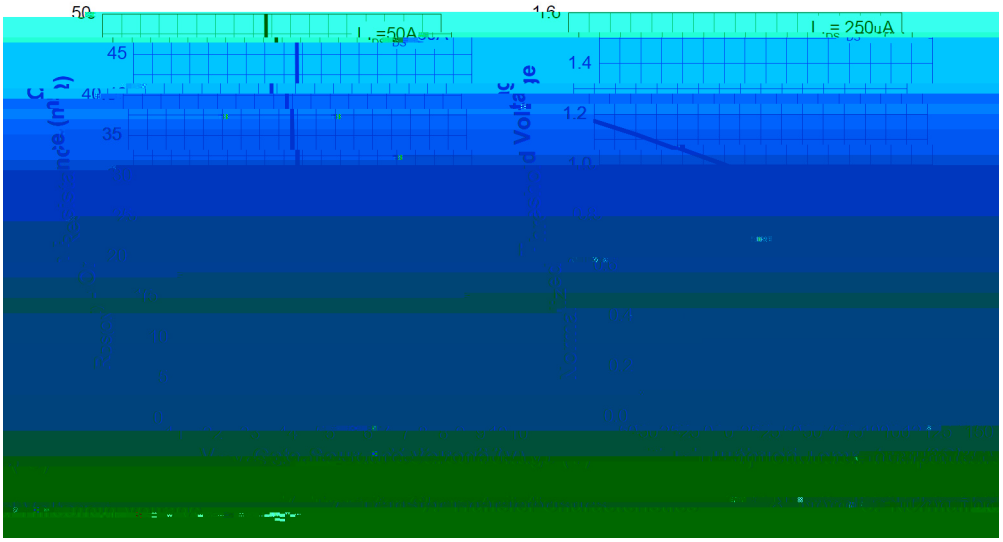
/ Electrical Characteristic Curve

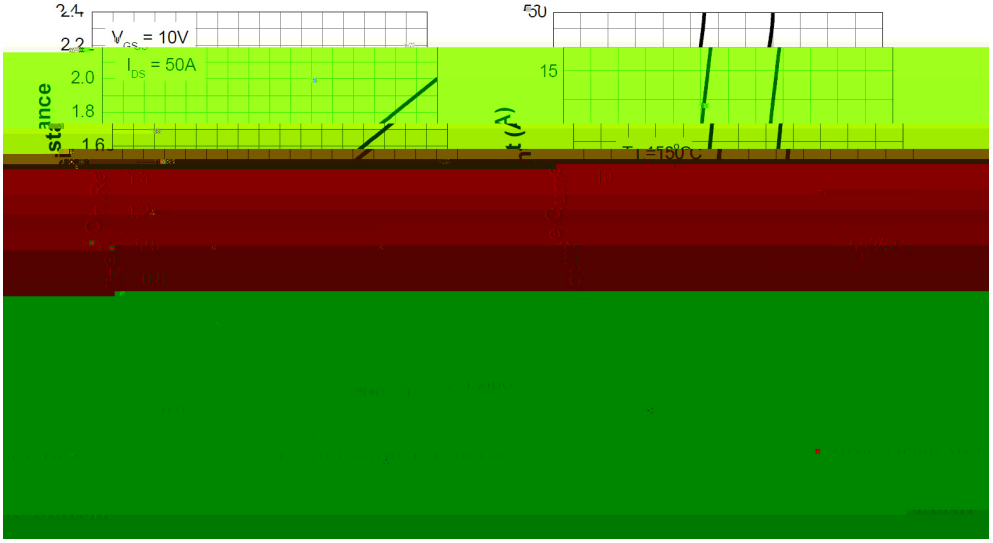


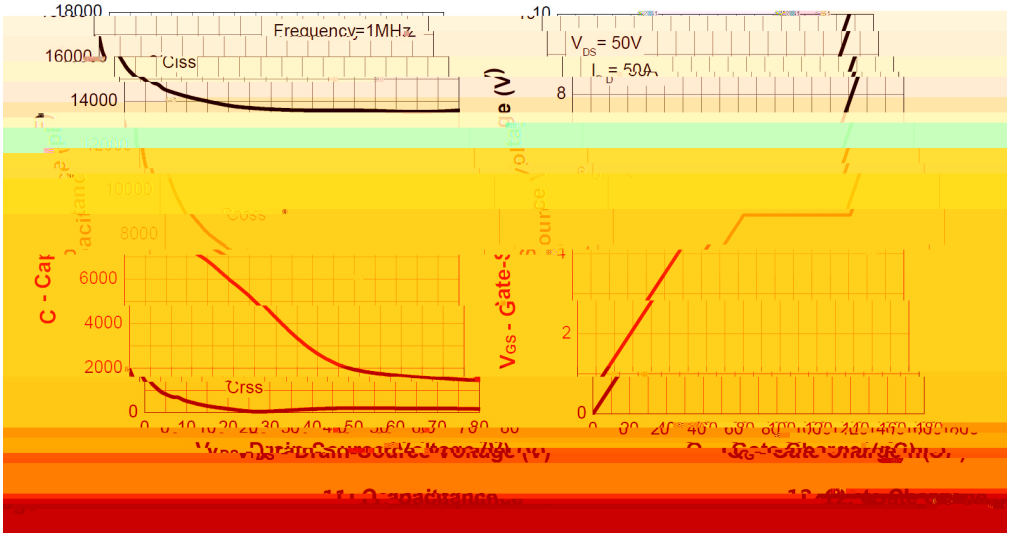




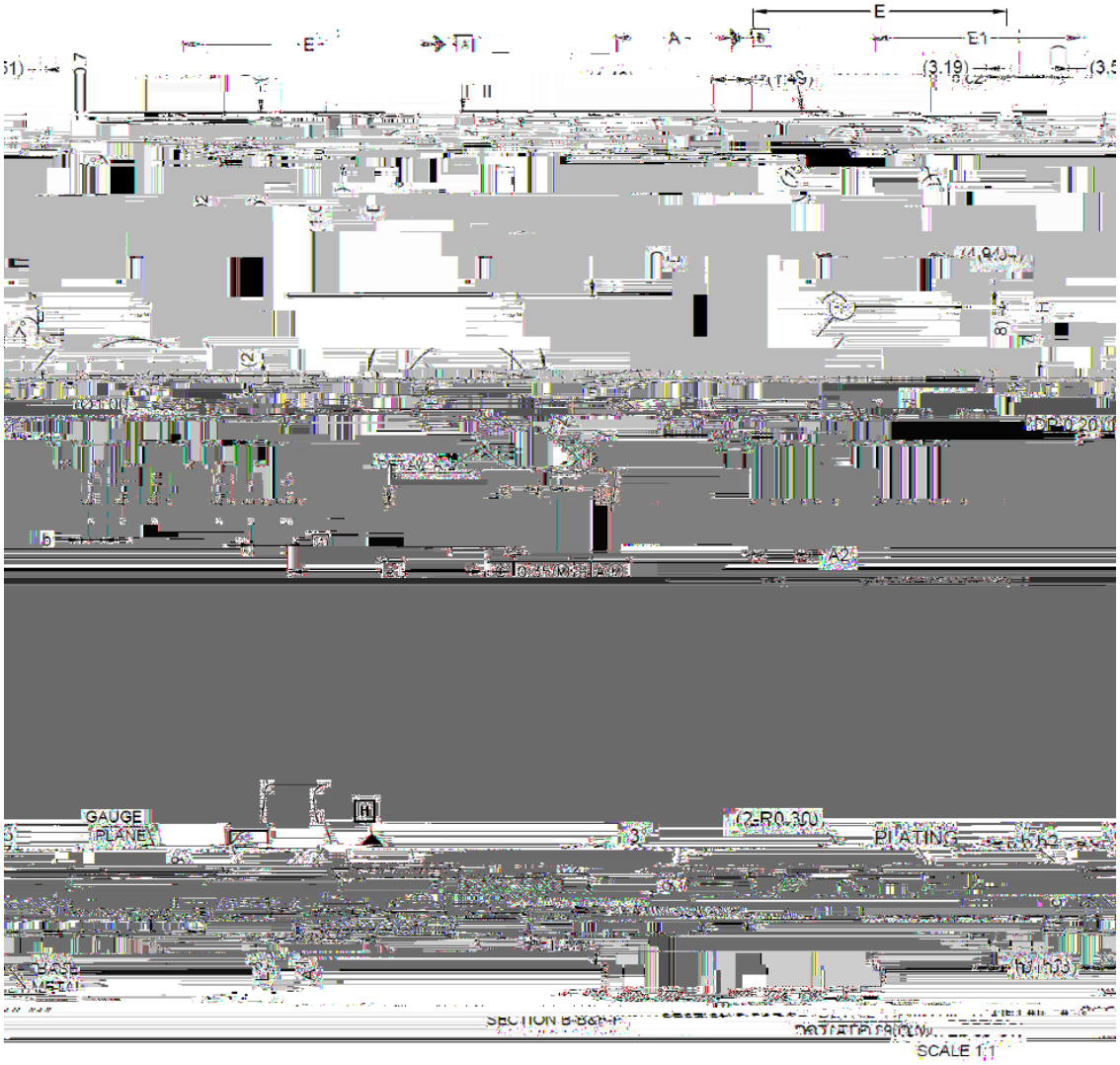
/ Electrical Characteristic Curve







/ Package Dimensions



Symbol	Dimensions In Millimeters		Symbol	Dimensions In Millimeters	
D1	6.86	7.42	A	4.30	4.70
E	9.68	10.08	A1		0.25
1	7.70	8.30	A2	2.20	2.60
0.85	e	1.27 BSC		b	0.65
0.80	e1	7.62 BSC		b1	0.65
1.00	L	1.78	2.79	b2	0.80
0.45	0.60	L2	-	1.78	c
0.45	0.55	L3	0.25BSD		c1
1.25	1.40	H	14.61	15.88	c2
9.00	9.40				D

( ) / Temperature Profile for IR Reflow Soldering(Pb-Free)

± ± ± ±

/ Resistance to Soldering Heat Test Conditions

±